S2A THRU S2M

GROWCHILD ELECTRONICSTM

SURFACE MOUNT GLASS PASSIVATED SILICON RECTIFIER

REVERSE VOLTAGE: 50 to 1000 VOLTS FORWARD CURRENT: 2.0 AMPERE

http://www.njzrg.com

FEATURES

- · For surface mounted applications
- · Low profile package
- · Built-in strain relief
- · Easy pick and place
- · Low forward voltage drop
- · Plastic package has Underwriters Laboratory

Flammability Classification 94V-O

· High temperature soldering : 260°C /10 seconds at terminals

MECHANICAL DATA

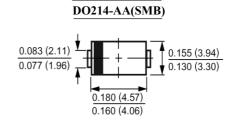
Case: Molded plastic, DO-214AA(SMB)

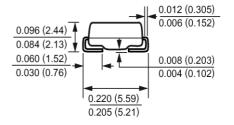
Terminals: Solder plated, solderable per MIL-STD-750,

method 2026 guaranteed

Polarity: Color band denotes cathode end Packaging: 12mm tape per EIA STD RS-481

Weight: 0.003 ounce, 0.093 gram





Dimensions in inches and (millimeters)

Maximum Ratings and Electrical Characteristics

Ratings at 25 ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

	Symbols	S2A	S2B	S2D	S2G	S2J	S2K	S2M	Units
Maximum Recurrent Peak Reverse Voltage	V _{RRM}	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage	V _{RMS}	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	Volts
Maximum Average Forward Rectified Current at T_L =90	$I_{(AV)}$		•		2.0				Amp
Peak Forward Surge Current,									
8.3ms single half-sine-wave	I _{FSM}	I _{FSM} 50							Amp
superimposed on rated load (JEDEC method)									
Maximum Forward Voltage at 2.0A	$V_{\rm F}$	1.15							Volts
Maximum Reverse Current at T _A =25	т	5.0 125							μАтр
at Rated DC Blocking Voltage T _A =125	I_R								
Typical Junction Capacitance (Note 1)	C_{J}	30							pF
Typical Thermal Resistance (Note 2)	$R_{ heta JL}$	16							/W
Maximum Reverse Recovery Time (Note 3)	T_{RR}	2.5							μS
Operating Junction Temperature Range	$T_{\mathbf{J}}$	-55 to +150							
Storage Temperature Range	Tstg	-55 to +150							

NOTES:

- 1- Measured at 1 MHz and applied reverse voltage of 4.0 VDC.
- 2- Thermal resistance from junction to lead mounted on P.C.B. with 0.3 x 0.3" (8.0 x 8.0mm) copper pad areas
- 3- Reverse Recovery Test Conditions : I_F =.5A , I_R =1A , I_{RR} =.25A.



RATINGS AND CHARACTERISTIC CURVES

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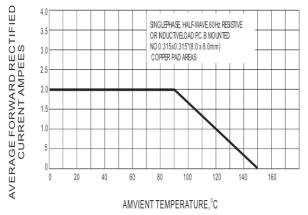
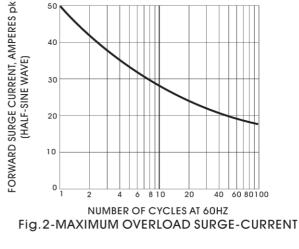


Fig. 3-MAXIMU AVERAGE FORWARD CURRENT RATING



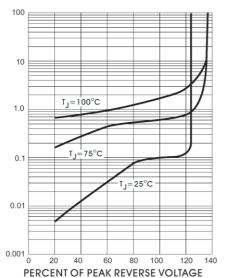


Fig. 3- TYPICAL REAK REVERSE CHARACTERISTICS

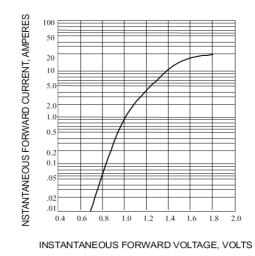


Fig. 4-TYPICAL INSTANTANEOUS FORWARD **CHARACTERISTICS**

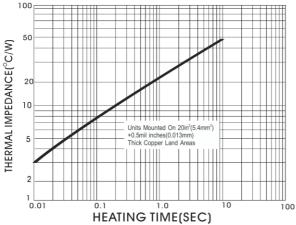


Fig. 5- TRANSIENT THERMAL IMPEDANCE

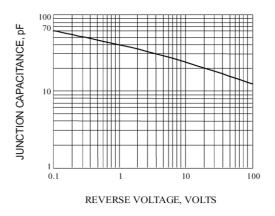


Fig. 6-TYPICAL JUNCTION CAPACITANCE